



DONGGUAN NANJING ELECTRONICS LTD.,
TO-247-2 Silicon Carbide Schottky Diode

NJ20PS065A SiC Diode 650V, 20A, 44nC

General Description

This product family offers state of the art performance. It is designed for high frequency applications here high efficiency and high reliability are required.

Features

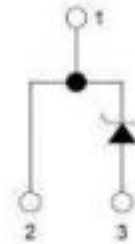
- Zero Forward/Reverse Recovery Current
- High Blocking Voltage
- High Frequency Operation
- Positive Temperature Coefficient on VF
- Temperature Independent Switching Behavior



**TO-247-2
Pin definition**

Applications

- Motor Drives
- Solar/Wind Inverters
- AC/DC converters
- DC/DC converters
- Uninterruptable power supplies



Benefits

- Higher System Efficiency
- Parallel Device Convenience without thermal runaway
- Higher Temperature Application
- No Switching loss
- Hard Switching & Higher Reliability
- Environmental Protection

Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handing procedures.

Typical Characteristics

Key performance parameters

Type	V_R	I_F $T_C=145^\circ\text{C}$	QC $V_R=400\text{V}$
NJ20PD065A	650V	20A	44nC

Maximum Ratings

$T_C=25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit	Test conditions
Peak Repetitive Reverse Voltage	V_{RRM}	650	V	-
Peak Reverse Surge Voltage	V_{RSM}	650	V	-
DC Blocking Voltage	V_R	650	V	-
Continuous Forward Current (per leg / per device)	I_F	55 24 20	A	$T_C = 25^\circ\text{C}$ $T_C = 135^\circ\text{C}$ $T_C = 145^\circ\text{C}$
Non repetitive Forward Surge Current *	I_{FSM}	120 110	A	tp =10 ms, Half Sine Pulse $T_C = 25^\circ\text{C}$, $T_C = 110^\circ\text{C}$
Repetitive peak Forward Surge Current *	I_{FRM}	110 100	A	tp =10 ms, Freq = 0.1Hz 100 cycles, Half Sine Pulse $T_C = 25^\circ\text{C}$ $T_C = 110^\circ\text{C}$
Total power dissipation (per leg / per device)	P_D	167	W	$T_C = 25^\circ\text{C}$
Operating Junction Temperature	T_J	-55 to 175	$^\circ\text{C}$	
Storage Temperature	T_{STG}	-55 to 175	$^\circ\text{C}$	

Typical Characteristics

Thermal Characteristics

Parameter	Condition	Symbol	Typ.	Unit
Thermal resistance(per device)	junction-case	Rth(j-c)	0.9	°C/W

Electrical Characteristics

$T_C = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value			Unit	Test Condition
		Min.	Typ.	Max.		
DC Blocking Voltage	V_{DC}	650	-	-	V	$I_R = 250\mu\text{A}$ $T_J = 25^\circ\text{C}$
Forward Voltage	V_F	-	1.5 1.6 1.7	1.8 - -	V	$I_F = 20\text{A}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ $T_J = 175^\circ\text{C}$
Reverse Current	I_R	-	20 120 250	80 - -	μA	$V_R = 650\text{V}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ $T_J = 175^\circ\text{C}$
Total Capacitance Charge	Q_C	-	44	-	nC	$V_R = 400\text{V}$ $T_J = 25^\circ\text{C}$
Total Capacitance	C	-	770 90 64	- - -	pF	$T_J = 25^\circ\text{C}$, Freq = 1MHz $V_R = 1\text{V}$ $V_R = 200\text{V}$ $V_R = 400\text{V}$

Characteristics Curves

Fig1: Forward Characteristics

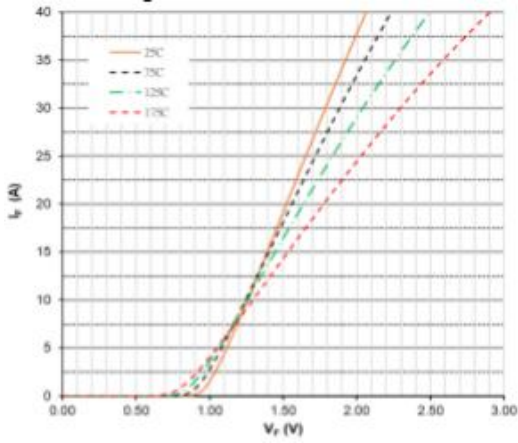


Fig 2: Forward Characteristics

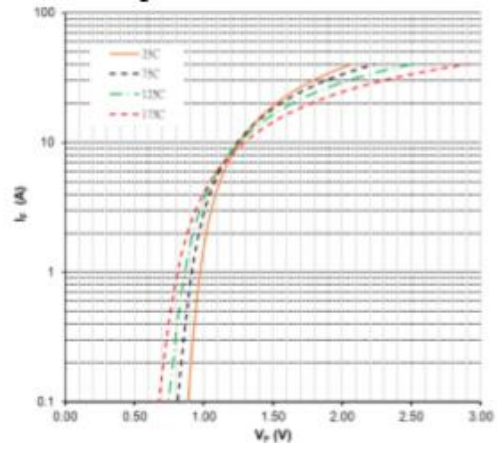


Fig 3: Reverse Characteristics

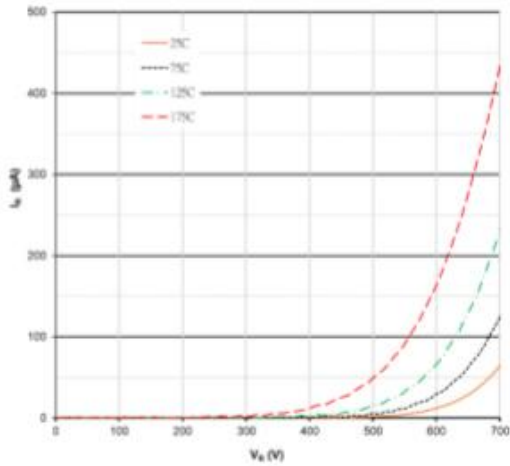


Fig 4: Power Derating

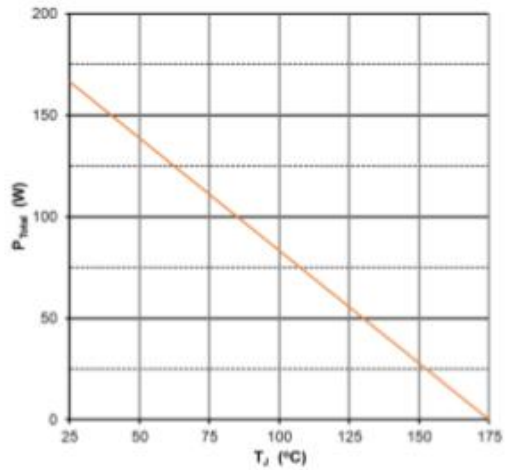


Fig5: Capacitance vs. Reverse Voltage

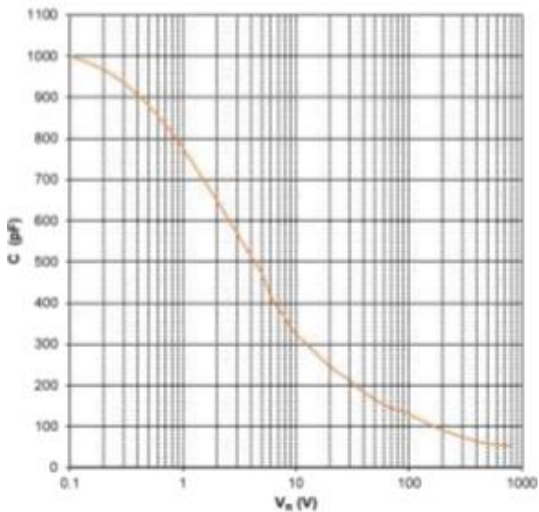


Fig 6: Recovery Charge vs. Reverse Voltage

